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With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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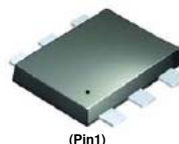


BAS70SV

70 V Dual-Schottky Barrier Diodes

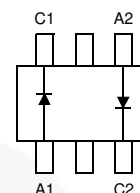
Features

- Low Forward-Voltage Drop
- Low Capacitance
- Low Leakage Current
- Fast Switching
- Ultra-Small Surface-Mount Package
- Lead Free by Design / RoHS Compliant
- Green Compound
- 0.6mm Maximum Package Height



(Pin1)
SOT-563F

BAS70SV Marking : AD



ELECTRICAL SYMBOL

Note: Pinouts are symmetrical. Pin 1 & 4 are interchangeable.
The placement of the device in the carrier tape can be of either orientation.

Ordering Information

Part Number	Marking	Package	Packing Method
BAS70SV	AD	SOT-563F 6L	Tape and Reel

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Units
V_{RRM}	Maximum Repetitive Reverse Voltage	70	V
$I_{F(AV)}$	Average Rectified Forward Current	70	mA
I_{FSM}	Forward Surge Current (8.3mS Single Half Sine Wave)	2.5	A
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 to +150	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Value	Units
P_D	Power Dissipation	200	mW
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient ⁽¹⁾	625	$^\circ\text{C}/\text{W}$

Note:

1. Device mounted on board compliant to JESD51-2 and JESD51-3 standards.

Electrical Characteristics

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
V_{BR}	Breakdown Voltage	$I_R = 100 \mu\text{A}$	70	93		V
I_R	Reverse Current	$V_R = 50 \text{ V}$		0.02	0.10	μA
		$V_R = 70 \text{ V}$			2.5	μA
V_F	Forward Voltage	$I_F = 1 \text{ mA}$		365	410	mV
		$I_F = 15 \text{ mA}$		855	1000	mV
t_{rr}	Reverse-Recovery Time	$I_F = I_R = 10 \text{ mA}$, $I_{rr} = 0.1 I_R$		1.55	8.00	ns
Cap	Capacitance	$V_R = 0 \text{ V}$, $f = 1 \text{ MHz}$		1.62	3.00	pF

Typical Performance Characteristics

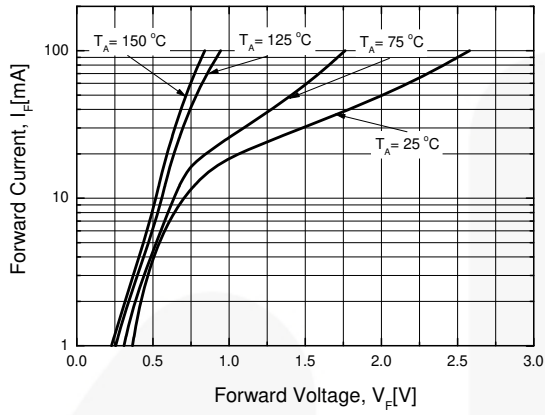


Figure 1. Forward Current Characteristics

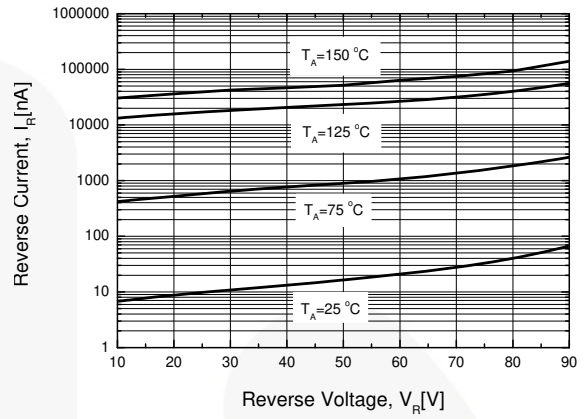


Figure 2. Reverse Leakage Current

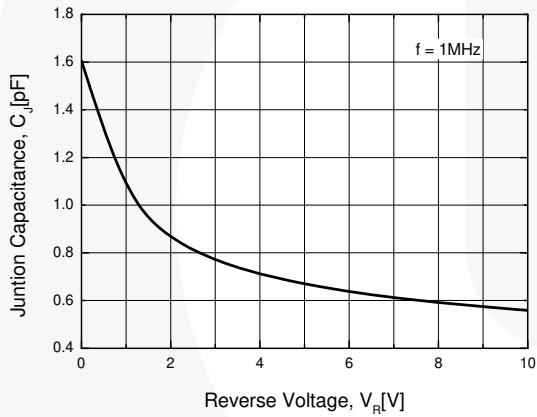


Figure 3. Junction Capacitance

Physical Dimensions

SOT-563F 6L

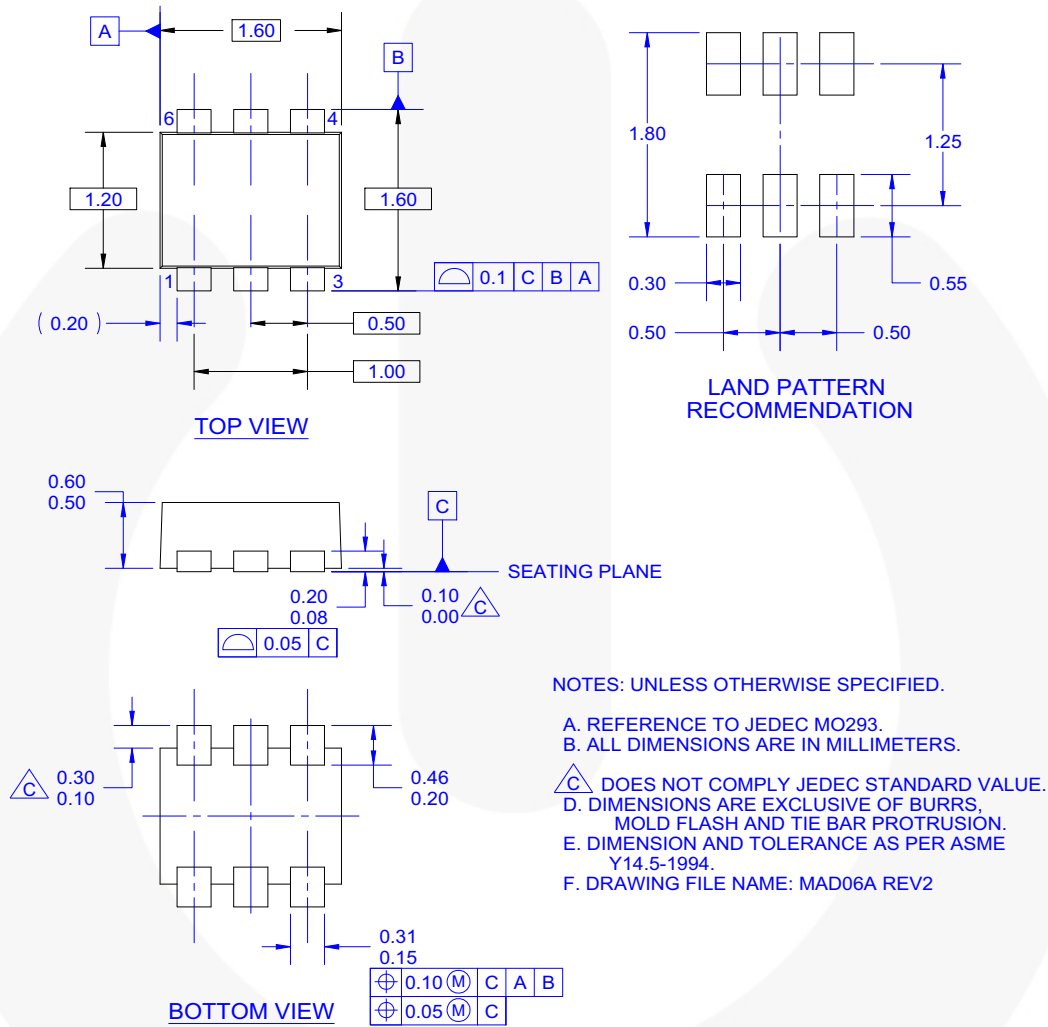


Figure 4. 6-LEAD, MO293, 1.2 MM WIDE, SOT563F, DUAL DAP (ACTIVE)

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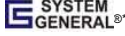



<http://www.fairchildsemi.com/packaging/>

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http://www.fairchildsemi.com/packing_dwg/PKG-MAD06A_BK.pdf

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Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
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